

#### **AMP-LATCH**

TE Internal #: 2-746610-6

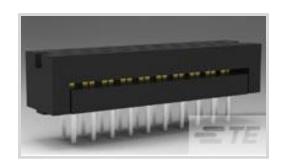
Ribbon Cable Connectors, Wire-to-Board, 44 Position, .1 in [2.54 mm] Centerline, Vertical, Through Hole - Solder, Insulation

Displacement (IDC), 2 Row

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Wire-to-Board

Number of Positions: 44

Centerline (Pitch): 2.54 mm [.1 in] PCB Mount Retention: Without PCB Mount Orientation: Vertical

#### **Features**

#### **Product Type Features**

Connector Type	Connector Assembly
Ribbon Cable Connector Header Type	Pin Header
Connector Product Type	Connector Assembly
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board, Wire & Cable

### **Configuration Features**

Number of Positions	44
PCB Mount Orientation	Vertical
Number of Rows	2

#### **Electrical Characteristics**

UL Voltage Rating	250 VAC
Insulation Resistance	5000 MΩ
Operating Voltage	250 VAC

### **Body Features**

Daisy Chain	Without
Connector Profile	Standard

#### **Contact Features**



Contact Layout	Inline
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Type	Pin
Wire Contact Termination Area Plating Thickness	.127 μm[5 μin]
Wire Contact Termination Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	1 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.32 mm[.013 in]
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Termination Post & Tail Length	3.96 mm[.156 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Method to Wire & Cable	Insulation Displacement (IDC)
Mechanical Attachment	
Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	Without
Mating Alignment Type	Polarization
Mating Retention	Without
Connector Mounting Type	Board Mount
Connector Mounting Type  Housing Features	Board Mount
	Board Mount  Thermoplastic
Housing Features	
Housing Features  Housing Material	Thermoplastic
Housing Features  Housing Material  Housing Color	Thermoplastic Black
Housing Features  Housing Material  Housing Color  Centerline (Pitch)	Thermoplastic Black
Housing Features  Housing Material  Housing Color  Centerline (Pitch)  Dimensions	Thermoplastic  Black 2.54 mm[.1 in]
Housing Features  Housing Material  Housing Color  Centerline (Pitch)  Dimensions  Connector Length	Thermoplastic  Black 2.54 mm[.1 in]  60.45 mm[2.38 in]
Housing Features  Housing Material  Housing Color  Centerline (Pitch)  Dimensions  Connector Length  Connector Height	Thermoplastic  Black  2.54 mm[.1 in]  60.45 mm[2.38 in]  6.43 mm[.253 in]



PCB Thickness (Recommended)	3.18 mm[.125 in]
Accepts Wire Insulation Diameter Range	.81 – 1.07 mm[.032 – .042 in]
Row-to-Row Spacing	2 mm[.1 in]
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
Industry Standards	
Industry Standards  CSA File Number	LR 7189
	LR 7189 Recognized
CSA File Number	
CSA File Number  UL Rating	Recognized
CSA File Number  UL Rating  Agency/Standard	Recognized CSA, UL
CSA File Number  UL Rating  Agency/Standard  UL File Number	Recognized CSA, UL E28476

## **Product Compliance**

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Box & Tube, Tube

Product Compliance Disclaimer

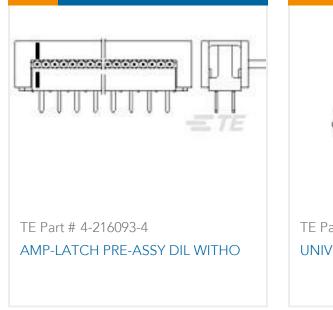
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

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chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts





# **Customers Also Bought**













TE Part #749842-000 GEL-B-3-240

### **Documents**

Product Drawings
044 DIP PLUG 100CL TIN

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 



ENG\_CVM\_CVM\_2-746610-6\_F.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-746610-6\_F.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-746610-6\_F.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

**Ribbon Cable Interconnect Solutions** 

English

**Product Specifications** 

**Application Specification** 

English

**Product Environmental Compliance** 

**TE Material Declaration** 

English

**Instruction Sheets** 

Instruction Sheet (U.S.)

English